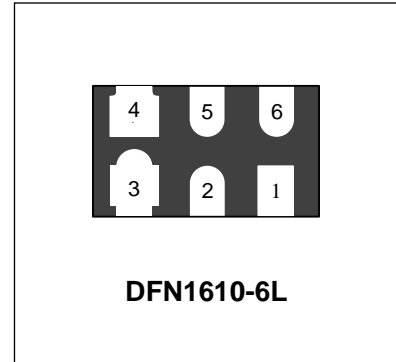


Features

- Solid-state silicon-avalanche technology
- Low operating and clamping voltage
- Up to two I/O Lines of Protection
- Ultra low capacitance
- Low operating voltage:5V
- Low Leakage Current



IEC COMPATIBILITY (EN61000-4)

- IEC 61000-4-2 (ESD) $\pm 30\text{kV}$ (air), $\pm 30\text{kV}$ (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 5A (8/20 μs)

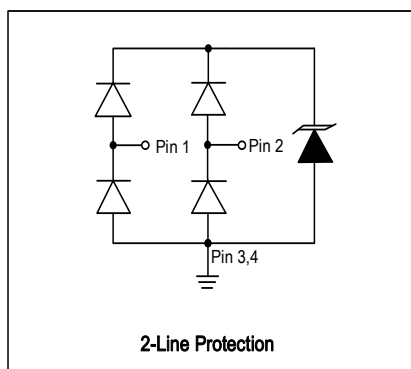
Mechanical Characteristics

- DFN1610-6L package
- Marking : Marking Code
- Packaging : Tape and Reel per EIA 481
- RoHS Compliant

Applications

- Digital Visual Interface(DVI)
- MDDI Ports
- Display Port TM Interface
- PCI Express
- High Definition Multi-Media Interface(HDMI)
- HDMI Interfaces

Circuit Diagram



Schematic & PIN Configuration

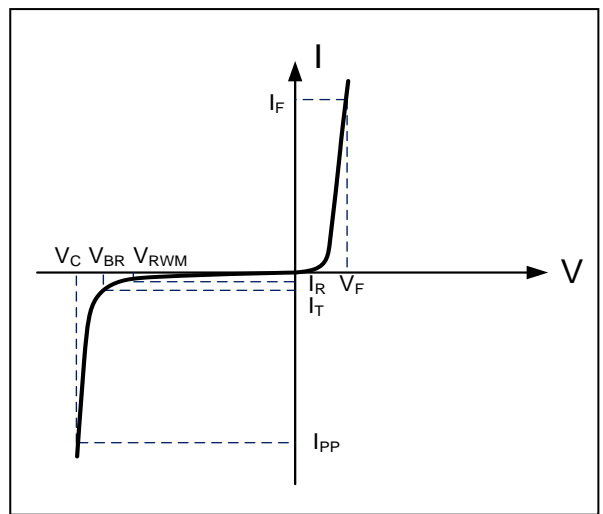


Pin	Identificaion
1,2	Input line
5,6	Output Lines (No Internal Connection)
3,4	Ground

Absolute Maximum Rating			
Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PP}	65	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{PP}	5	A
Operating Temperature	T_J	-55 to + 125	$^{\circ}C$
Storage Temperature	T_{STG}	-55 to +150	$^{\circ}C$

Electrical Parameters (T=25°C)

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Reverse Stand-Off Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F



Electrical Characteristics

WS05-2R2P						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				5	V
Reverse Breakdown Voltage	V_{BR}	$I_T = 1mA$	5.6		10	V
Reverse Leakage Current	I_R	$V_{RWM} = 5V, T = 25^{\circ}C$			500	nA
Clamping Voltage	V_C	$I_{PP} = 5A, t_p = 8/20\mu s$		10	13	V
Dynamic Resistance ^{1,2}	R_{DYN}	$TLP = 0.2/100ns$		0.23		Ω
ESD Clamping Voltage ¹	V_C	$I_{PP} = 4A$ $t_p = 0.2/100ns$		8.9		V
ESD Clamping Voltage ¹	V_C	$I_{PP} = 16A$ $t_p = 0.2/100ns$		11.7		V
Junction Capacitance	C_j	$V_R = 0V, f = 1MHz$ I/O pin to GND		0.8	1.2	pF
		$V_R = 0V, f = 1MHz$ Between I/O pins		0.4	0.6	pF

Note: 1、 TLP Setting : $t_p = 100ns, t_r = 0.2ns, I_{TLP}$ and V_{TLP} sample window: $t_1 = 70ns$ to $t_2 = 90ns$.
 2、 Dynamic resistance calculated from $I_{PP} = 4A$ to $I_{PP} = 16A$ using "Best Fit"

Typical Characteristics

Figure 1: Peak Pulse Power Vs Pulse Time

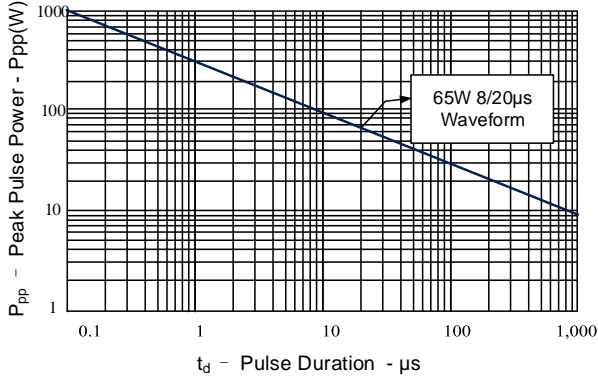


Figure 2: Power Derating Curve

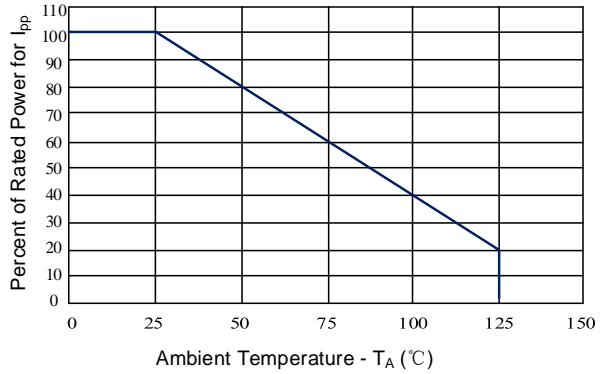


Figure 3: Clamping Voltage vs. Peak Pulse Current

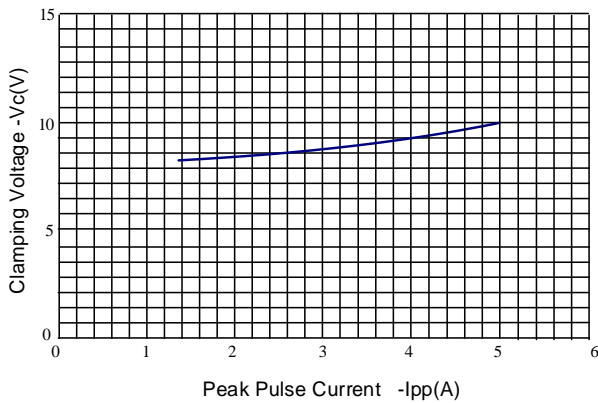


Figure 4: Normalized Junction Capacitance vs. Reverse Voltage

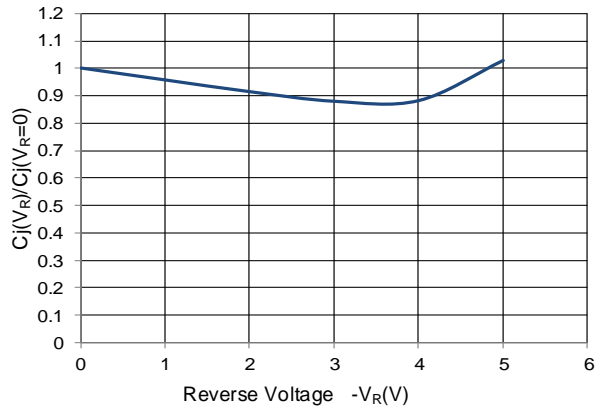


Figure 5: Pulse Waveform

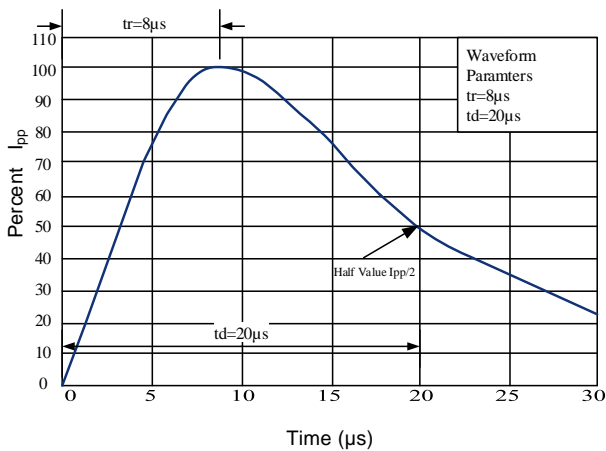
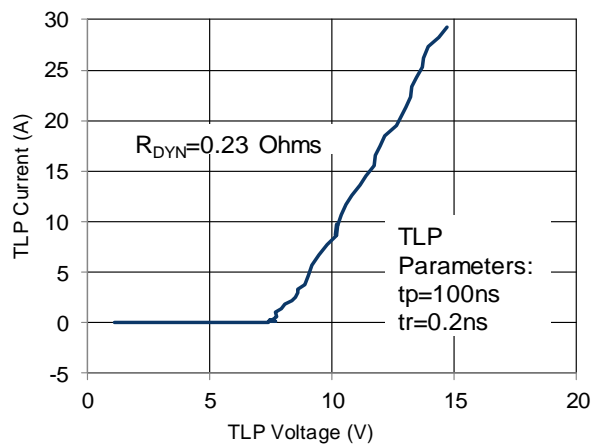
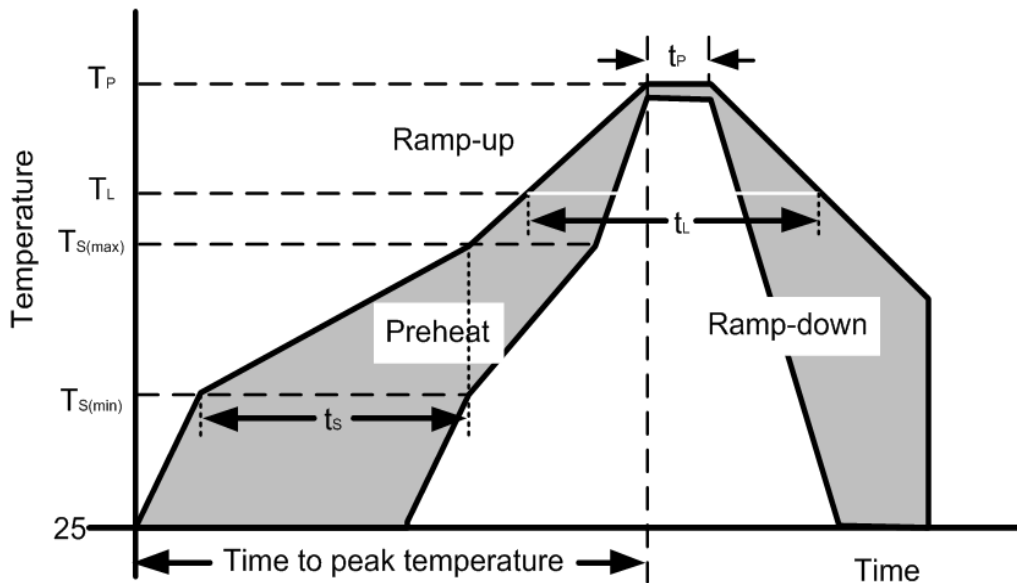


Figure 6: TLP I-V Curve



Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min ($T_{S(min)}$)	150°C
	Temperature Max ($T_{S(max)}$)	200°C
	Time (min to max) (t_s)	60 – 190 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		5°C/second max
$T_{S(max)}$ to T_L —Ramp-up Rate		5°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_P)		260+0/-5 °C
Time within actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		280°C



Outline Drawing – DFN1610-6L

SYMBOL	MILLIMETERS		
	MIN	NOM	MAX
A	0.50	0.55	0.60
A1	-	0.02	0.05
b	0.15	0.20	0.25
b1	0.35	0.40	0.45
b2	0.20	0.25	0.30
c	0.10	0.15	0.20
D	1.55	1.60	1.65
e	0.50BSC		
E	0.95	1.00	1.05
L	0.33	0.38	0.43
L1	0.10REF		
L2	0.05REF		
L3	0.49REF		
R	0.08	0.13	0.18

DIMENSIONS		
DIM	INCHES	MILLIMETERS
C	0.024	0.60
G	0.004	0.10
P	0.020	0.50
P1	0.039	1.00
X	0.012	0.30
Y	0.020	0.50
Y1	0.043	1.10

Notes:
Controlling Dimension: Millimeter.

Marking Codes

Part Number	Marking Code
WS05-2R2P	2R2P

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

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For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.
 The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
 Users should verify actual device performance in their specific applications.

单击下面可查看定价，库存，交付和生命周期等信息

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